/ Descriptions

VRS0; ṂṂ Ꝉ ᵴ Q ᵾ PRV ʃ ᾠ Ẓ ᵑ
Grxe₀h Q0FKDQQH0 PRVIHW lq d VRS0; S₀dvwlf Sdfndjh1

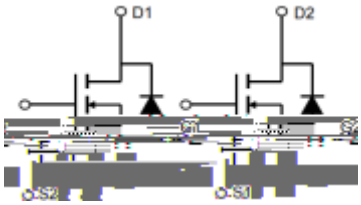
/ Features

V_{DS}(V)=30V I_D=16A
$R_{DS(ON)}$@10V<8mΩ(Typ. 7.6mR)
$R_{DS(ON)}$)@4.5V<12mΩ(Typ. 10.8mR)
ῆ ꜰ ᵝ HF Product.

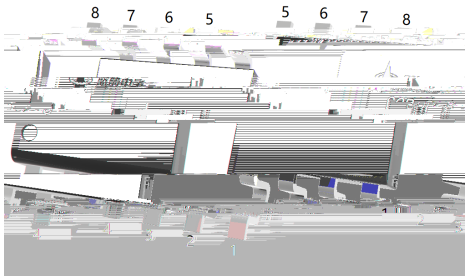
/ Applications

ᵻ PE2QE2X PSF2YJD ㊊ح ļ ق ذ ᴾ ª ℓ ں я ჯ Ὼ ʜ / ǐ ۔ GF0GF ɔ ד ۷ ۸ /ق U Ầ ʜ
Klj k luhtxhqf| Srlqw0ri00rdg V|qfkurqrxv Exfn Frqyhuwhu iru PE2QE2X PSF2YJD/
Qhwz runlqj GF0GF Sr zhu V|vwhp/0rdg Vzlwfk1

/ Equivalent Circuit



/ Pinning



PIN1 χ S1 PIN 2 χ G1 PIN 3 χ S2 PIN 4 χ G2
PIN 5 χ D2 PIN 6 χ D2 PIN 7 χ D1 PIN 8 χ D1

/ Marking

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See Marking Instructions.

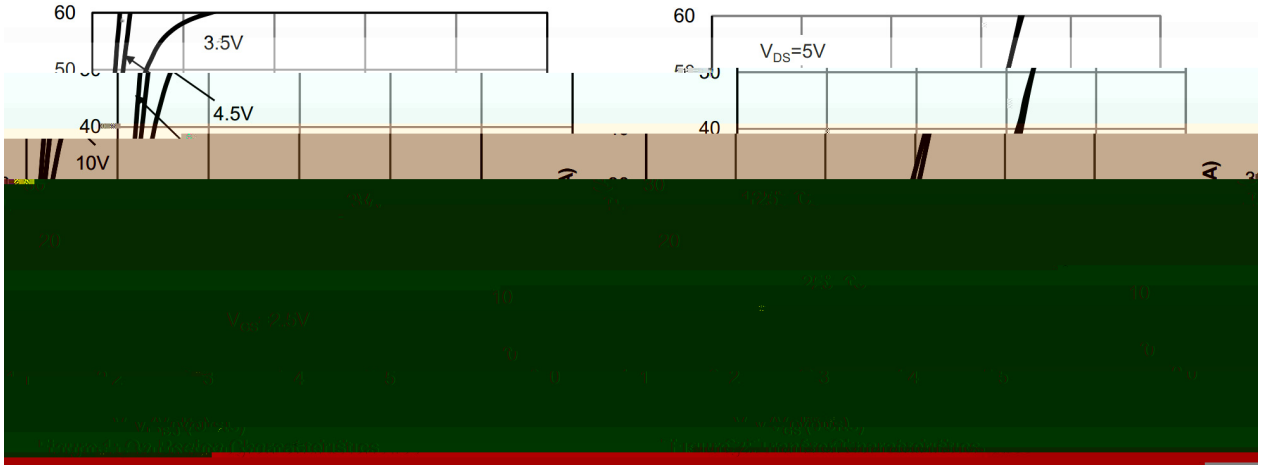
v ‴Ω Parameter	٩ N Symbol	‴Ω Ö Rating	D Ꮒ Unit
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	16	A
Pulsed Drain Current	I_{DM}	59	A
Power Dissipation	P_D	3.2	W
Junction and Storage Temperature Range	T_J,T_{STG}	-55 to +150	
Maximum Junction-to-Ambient	$R_{\theta JA}$(Steady-State)	39	/W

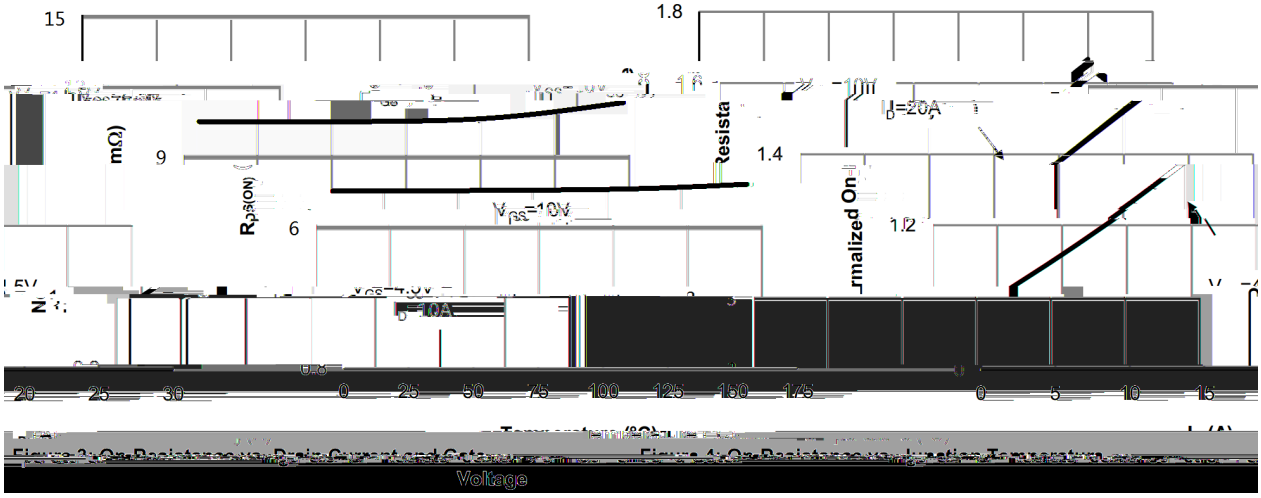
v ‴Ω Parameter	٩ N Symbol	‗ ;ˆ ţ Test Conditions	ώ ṇ Ö Min	Ɛ ʒ Ö Typ	ώ ᶻ Ö Max	D Ꮒ Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA	30	35		V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V V_{GS}=0V			1	μA
Gate-Body leakage current	I_{GSS}	V_{GS}=±20V V_{DS}=0V			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS} I_D=250μA	1.0	1.7		

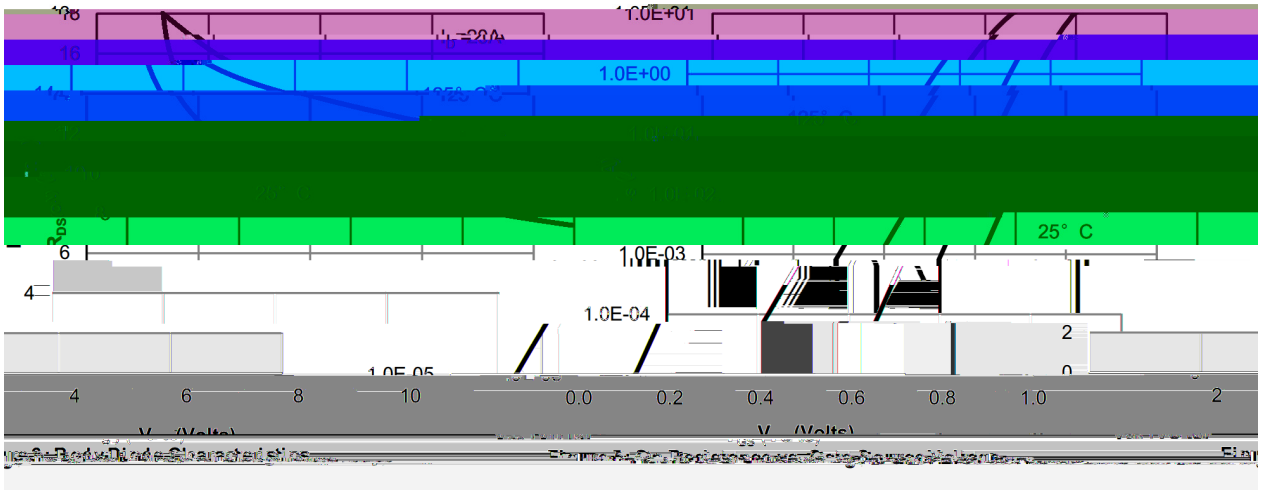
on

v ̈Ω Parameter	ϒ N Symbol	⊪ ;ϯ ϒ Test Conditions	ϣ ṇ Ө Min	Ɛ ʒ Ө Typ	ϣ ᶻ Ө Max	D Ꮋ Unit
Turn-On Delay Time	$t_{d(on)}$	V_{DS}=15 V V_{GS}=10V R=10V =10V 880006 Tc(=15V)Tj385 1 Tf330008 0 T57TcTc( )Tɟ1<020c				

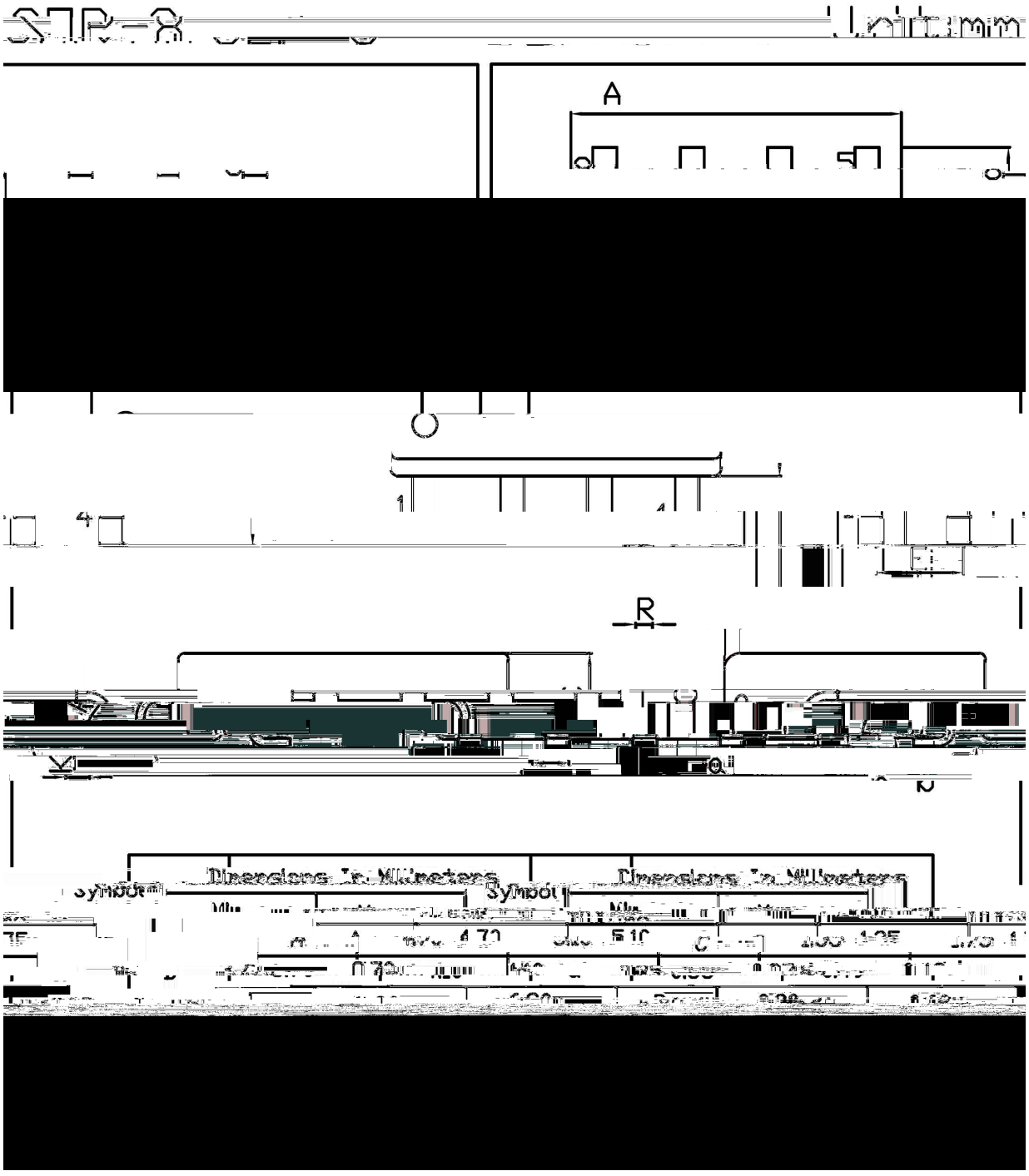
/ Electrical Characteristic Curve



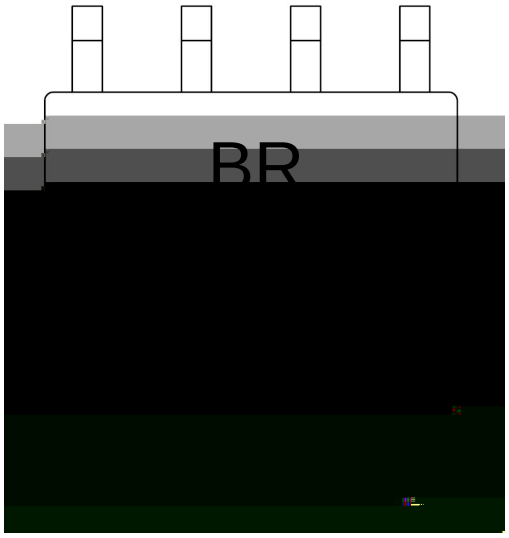




/ Package Dimensions



/ Marking Instructions



ب ˝ χ	
BR χ	ﻩﺭ ﺯ ﻧ ﻢ
080N03D χ	ﻩﺭ ﺯ ﻦ ﻢ
**** χ	ﻩﺭ ﺍ ﻓ ﻩ ﻦ ﻢ ﺍ ﻫ ﺍ ﻓ ﻩ ﻦ ﻳ ﻕ

Note:

BR:	Company Code
080N03D:	Product Type
****:	Lot No. Code, code change with Lot No

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

ب ˝ χ

1 Ĺ ♬ □ ỷ 150 Ḱ 180 ł ı `H ژ 60 Ḱ 90sec;

2 Š Ө □ ỷ 245 ° 5 ł ı `H ژ `Y ﾊ ㎞ 5 ° 0.5sec;

3 ì ˙ ﾘ ˛ ɔ ﷺ ỷ ㎞ 2 Ḱ 10 ł /sec.

Note:

1.Preheating:150~180 ł , Time:60~90sec.

2.Peak Temp.:245 ° 5 ł , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ł /sec.

/ Resistance to Soldering Heat Test Conditions

605 ° 5 ł